

---

# HM628512C Series

4 M SRAM (512-kword  $\times$  8-bit)

# HITACHI

ADE-203-1212C (Z)

Rev. 3.0

Aug. 5, 2002

---

## Description

The Hitachi HM628512C is a 4-Mbit static RAM organized 512-kword  $\times$  8-bit. It realizes higher density, higher performance and low power consumption by employing CMOS process technology (6-transistor memory cell). The device, packaged in a 525-mil SOP (foot print pitch width) or 400-mil TSOP TYPE II or 600-mil plastic DIP, is available for high density mounting. The HM628512C is suitable for battery backup system.

## Features

- Single 5 V supply
- Access time: 55/70 ns (max)
- Power dissipation
  - Active: 10 mW/MHz (typ)
  - Standby: 4  $\mu$ W (typ)
- Completely static memory. No clock or timing strobe required
- Equal access and cycle times
- Common data input and output: Three state output
- Directly TTL compatible: All inputs and outputs
- Battery backup operation

---

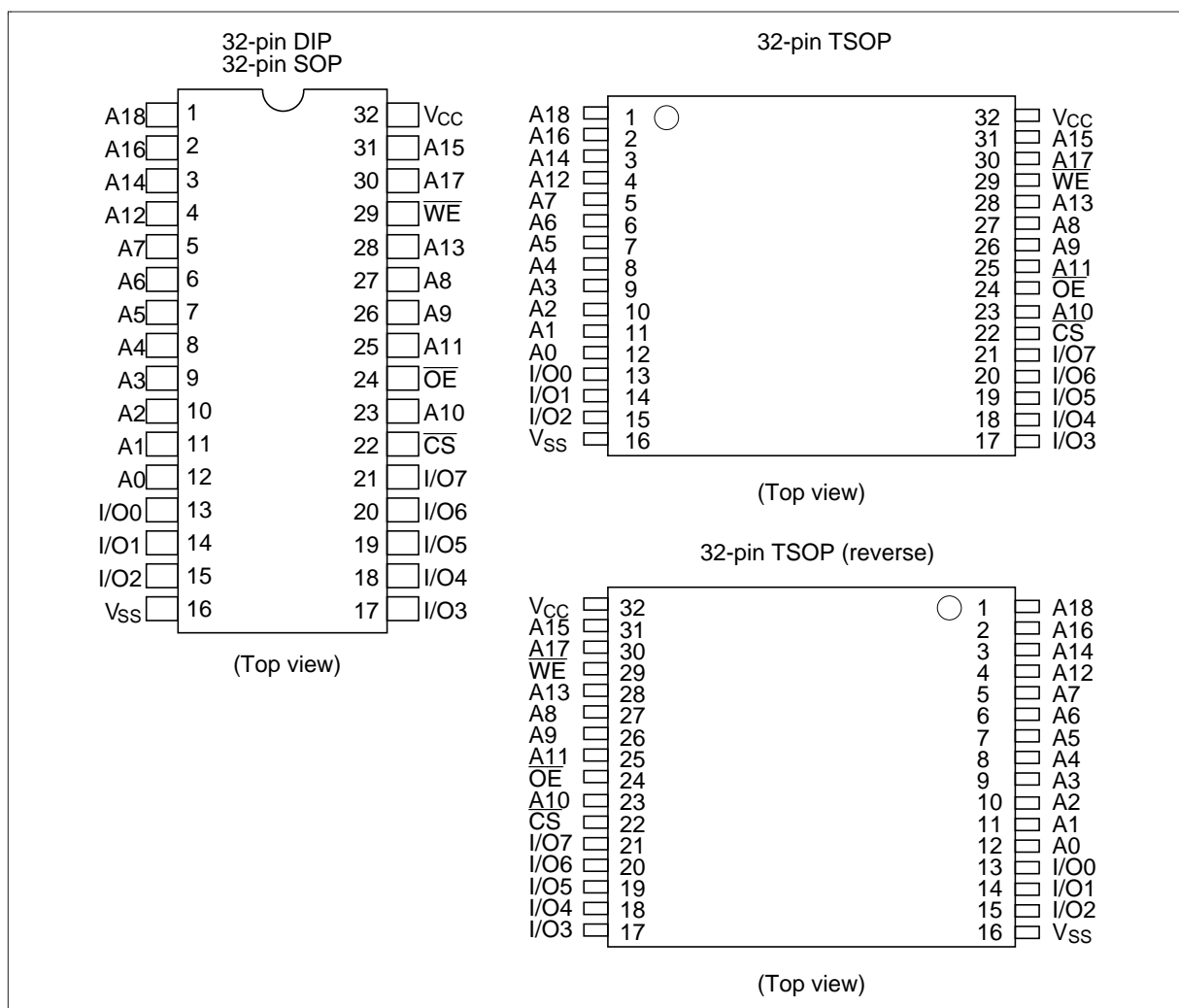
# HM628512C Series

---

## Ordering Information

Type No.	Access time	Package
HM628512CLP-7	70 ns	600-mil 32-pin plastic DIP (DP-32)
HM628512CLP-5SL	55 ns	
HM628512CLFP-7	70 ns	525-mil 32-pin plastic SOP (FP-32D)
HM628512CLFP-5SL	55 ns	
HM628512CLTT-7	70 ns	400-mil 32-pin plastic TSOP II (TTP-32D)
HM628512CLTT-5SL	55 ns	
HM628512CLRR-7	70 ns	400-mil 32-pin plastic TSOP II reverse (TTP-32DR)
HM628512CLRR-5SL	55 ns	

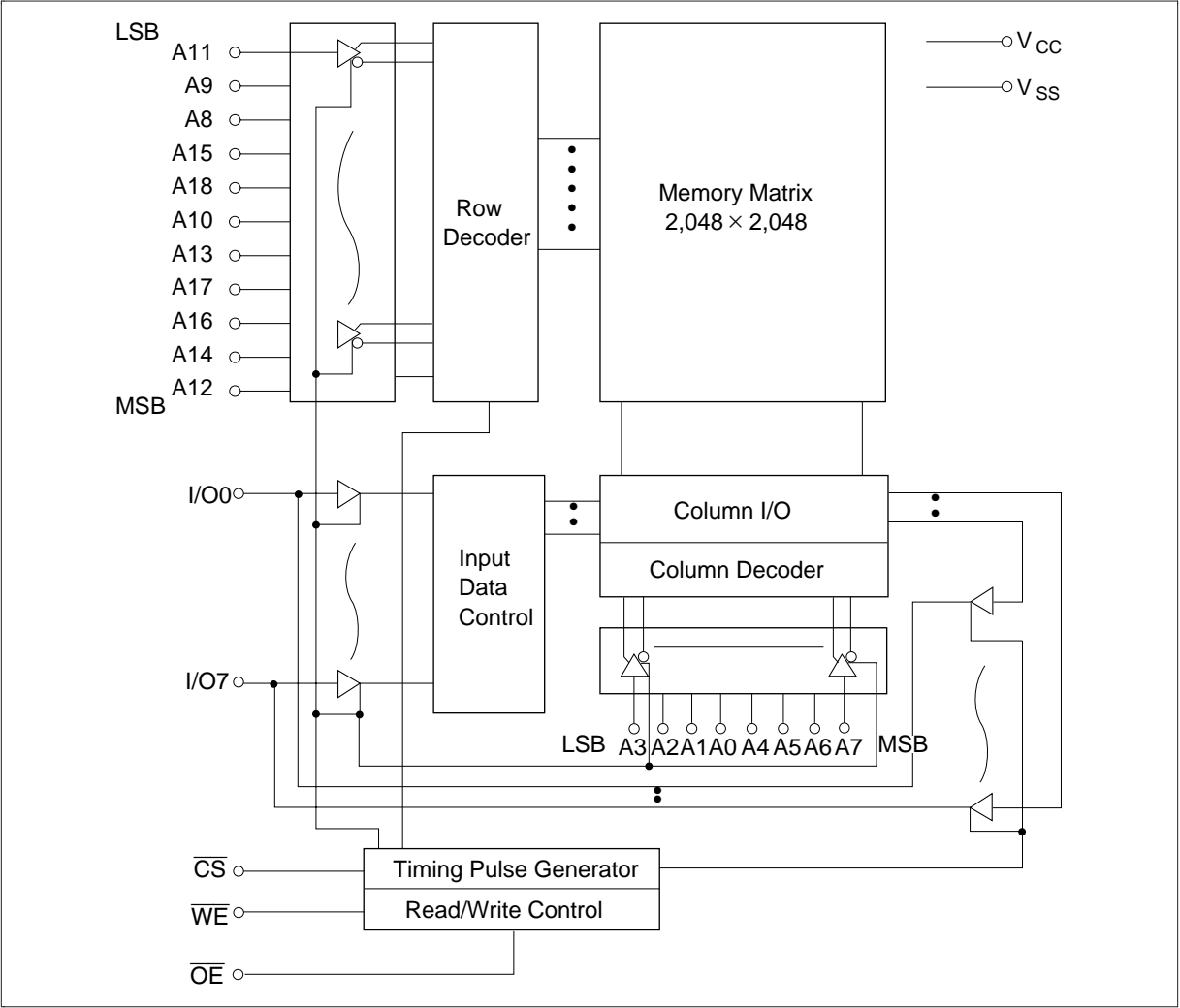
## Pin Arrangement



## Pin Description

Pin name	Function
A0 to A18	Address input
I/O0 to I/O7	Data input/output
CS	Chip select
OE	Output enable
WE	Write enable
V <sub>CC</sub>	Power supply
V <sub>SS</sub>	Ground

Block Diagram



## Function Table

$\overline{WE}$	$\overline{CS}$	$\overline{OE}$	Mode	$V_{CC}$ current	Dout pin	Ref. cycle
×	H	×	Not selected	$I_{SB}, I_{SB1}$	High-Z	—
H	L	H	Output disable	$I_{CC}$	High-Z	—
H	L	L	Read	$I_{CC}$	Dout	Read cycle
L	L	H	Write	$I_{CC}$	Din	Write cycle (1)
L	L	L	Write	$I_{CC}$	Din	Write cycle (2)

Note: ×: H or L

## Absolute Maximum Ratings

Parameter	Symbol	Value	Unit
Power supply voltage	$V_{CC}$	−0.5 to +7.0	V
Voltage on any pin relative to $V_{SS}$	$V_T$	−0.5* <sup>1</sup> to $V_{CC} + 0.3$ * <sup>2</sup>	V
Power dissipation	$P_T$	1.0	W
Operating temperature	$T_{opr}$	−20 to +70	°C
Storage temperature	$T_{stg}$	−55 to +125	°C
Storage temperature under bias	$T_{bias}$	−20 to +85	°C

Notes: 1.  $V_T$  min: −3.0 V for pulse half-width ≤ 30 ns.

2. Maximum voltage is 7.0 V.

Recommended DC Operating Conditions ( $T_a = -20$  to  $+70^\circ\text{C}$ )

Parameter	Symbol	Min	Typ	Max	Unit
Supply voltage	$V_{CC}$	4.5	5.0	5.5	V
	$V_{SS}$	0	0	0	V
Input high voltage	$V_{IH}$	2.2	—	$V_{CC} + 0.3$	V
Input low voltage	$V_{IL}$	−0.3* <sup>1</sup>	—	0.8	V

Note: 1.  $V_{IL}$  min: −3.0 V for pulse half-width ≤ 30 ns.

## DC Characteristics

Parameter	Symbol	Min	Typ* <sup>1</sup>	Max	Unit	Test conditions
Input leakage current	$ I_{LI} $	—	—	1	$\mu\text{A}$	$V_{in} = V_{SS} \text{ to } V_{CC}$
Output leakage current	$ I_{LO} $	—	—	1	$\mu\text{A}$	$\overline{CS} = V_{IH} \text{ or } \overline{OE} = V_{IH} \text{ or } \overline{WE} = V_{IL}, V_{I/O} = V_{SS} \text{ to } V_{CC}$
Operating power supply current: DC	$I_{CC}$	—	1.5	3	mA	$\overline{CS} = V_{IL}$ , others = $V_{IH}/V_{IL}$ , $I_{I/O} = 0 \text{ mA}$
Operating power supply current	HM628512C-5 $I_{CC1}$	—	8	25	mA	Min cycle, duty = 100% $\overline{CS} = V_{IL}$ , others = $V_{IH}/V_{IL}$ $I_{I/O} = 0 \text{ mA}$
	HM628512C-7 $I_{CC1}$	—	7	25	mA	
Operating power supply current	$I_{CC2}$	—	2	5	mA	Cycle time = 1 $\mu\text{s}$ , duty = 100% $I_{I/O} = 0 \text{ mA}$ , $\overline{CS} \leq 0.2 \text{ V}$ $V_{IH} \geq V_{CC} - 0.2 \text{ V}$ , $V_{IL} \leq 0.2 \text{ V}$
Standby power supply current: DC	$I_{SB}$	—	0.1	0.5	mA	$\overline{CS} = V_{IH}$
Standby power supply current (1): DC	$I_{SB1}$	—	0.8* <sup>2</sup>	20* <sup>2</sup>	$\mu\text{A}$	$V_{in} \geq 0 \text{ V}$ , $\overline{CS} \geq V_{CC} - 0.2 \text{ V}$
		—	0.8* <sup>3</sup>	10* <sup>3</sup>	$\mu\text{A}$	
Output low voltage	$V_{OL}$	—	—	0.4	V	$I_{OL} = 2.1 \text{ mA}$
Output high voltage	$V_{OH}$	2.4	—	—	V	$I_{OH} = -1.0 \text{ mA}$

Notes: 1. Typical values are at  $V_{CC} = 5.0 \text{ V}$ ,  $T_a = +25^\circ\text{C}$  and specified loading, and not guaranteed.

2. This characteristics is guaranteed only for L version.

3. This characteristics is guaranteed only for L-SL version.

## Capacitance ( $T_a = +25^\circ\text{C}$ , $f = 1 \text{ MHz}$ )

Parameter	Symbol	Typ	Max	Unit	Test conditions
Input capacitance* <sup>1</sup>	$C_{in}$	—	8	pF	$V_{in} = 0 \text{ V}$
Input/output capacitance* <sup>1</sup>	$C_{I/O}$	—	10* <sup>2</sup>	pF	$V_{I/O} = 0 \text{ V}$

Notes: 1. This parameter is sampled and not 100% tested.

2.  $C_{I/O} \text{ max} = 12 \text{ pF}$  only for HM628512CLP Series.

**AC Characteristics** ( $T_a = -20$  to  $+70^\circ\text{C}$ ,  $V_{CC} = 5\text{ V} \pm 10\%$ , unless otherwise noted.)

**Test Conditions**

- Input pulse levels: 0.8 V to 2.4 V
- Input rise and fall time: 5 ns
- Input and output timing reference levels: 1.5 V
- Output load: 1 TTL Gate +  $C_L$  (100 pF) (HM628512C-7)  
1 TTL Gate +  $C_L$  (50 pF) (HM628512C-5)  
(Including scope & jig)

**Read Cycle**

		HM628512C					
		-5		-7			
Parameter	Symbol	Min	Max	Min	Max	Unit	Notes
Read cycle time	t <sub>RC</sub>	55	—	70	—	ns	
Address access time	t <sub>AA</sub>	—	55	—	70	ns	
Chip select access time	t <sub>CO</sub>	—	55	—	70	ns	
Output enable to output valid	t <sub>OE</sub>	—	25	—	35	ns	
Chip selection to output in low-Z	t <sub>LZ</sub>	10	—	10	—	ns	2
Output enable to output in low-Z	t <sub>OLZ</sub>	5	—	5	—	ns	2
Chip deselection to output in high-Z	t <sub>HZ</sub>	0	20	0	25	ns	1, 2
Output disable to output in high-Z	t <sub>OHZ</sub>	0	20	0	25	ns	1, 2
Output hold from address change	t <sub>OH</sub>	10	—	10	—	ns	

## Write Cycle

		HM628512C					
		-5		-7			
Parameter	Symbol	Min	Max	Min	Max	Unit	Notes
Write cycle time	t <sub>WC</sub>	55	—	70	—	ns	
Chip selection to end of write	t <sub>CW</sub>	50	—	60	—	ns	4
Address setup time	t <sub>AS</sub>	0	—	0	—	ns	5
Address valid to end of write	t <sub>AW</sub>	50	—	60	—	ns	
Write pulse width	t <sub>WP</sub>	40	—	50	—	ns	3, 12
Write recovery time	t <sub>WR</sub>	0	—	0	—	ns	6
$\overline{WE}$ to output in high-Z	t <sub>WHZ</sub>	0	20	0	25	ns	1, 2, 7
Data to write time overlap	t <sub>DW</sub>	25	—	30	—	ns	
Data hold from write time	t <sub>DH</sub>	0	—	0	—	ns	
Output active from output in high-Z	t <sub>OW</sub>	5	—	5	—	ns	2
Output disable to output in high-Z	t <sub>OHZ</sub>	0	20	0	25	ns	1, 2, 7

Notes: 1.  $t_{HZ}$ ,  $t_{OHZ}$  and  $t_{WHZ}$  are defined as the time at which the outputs achieve the open circuit conditions and are not referred to output voltage levels.

2. This parameter is sampled and not 100% tested.

3. A write occurs during the overlap ( $t_{WP}$ ) of a low  $\overline{CS}$  and a low  $\overline{WE}$ . A write begins at the later transition of  $\overline{CS}$  going low or  $\overline{WE}$  going low. A write ends at the earlier transition of  $\overline{CS}$  going high or  $\overline{WE}$  going high.  $t_{WP}$  is measured from the beginning of write to the end of write.

4.  $t_{CW}$  is measured from  $\overline{CS}$  going low to the end of write.

5.  $t_{AS}$  is measured from the address valid to the beginning of write.

6.  $t_{WR}$  is measured from the earlier of  $\overline{WE}$  or  $\overline{CS}$  going high to the end of write cycle.

7. During this period, I/O pins are in the output state so that the input signals of the opposite phase to the outputs must not be applied.

8. If the  $\overline{CS}$  low transition occurs simultaneously with the  $\overline{WE}$  low transition or after the  $\overline{WE}$  transition, the output remain in a high impedance state.

9. Dout is the same phase of the write data of this write cycle.

10. Dout is the read data of next address.

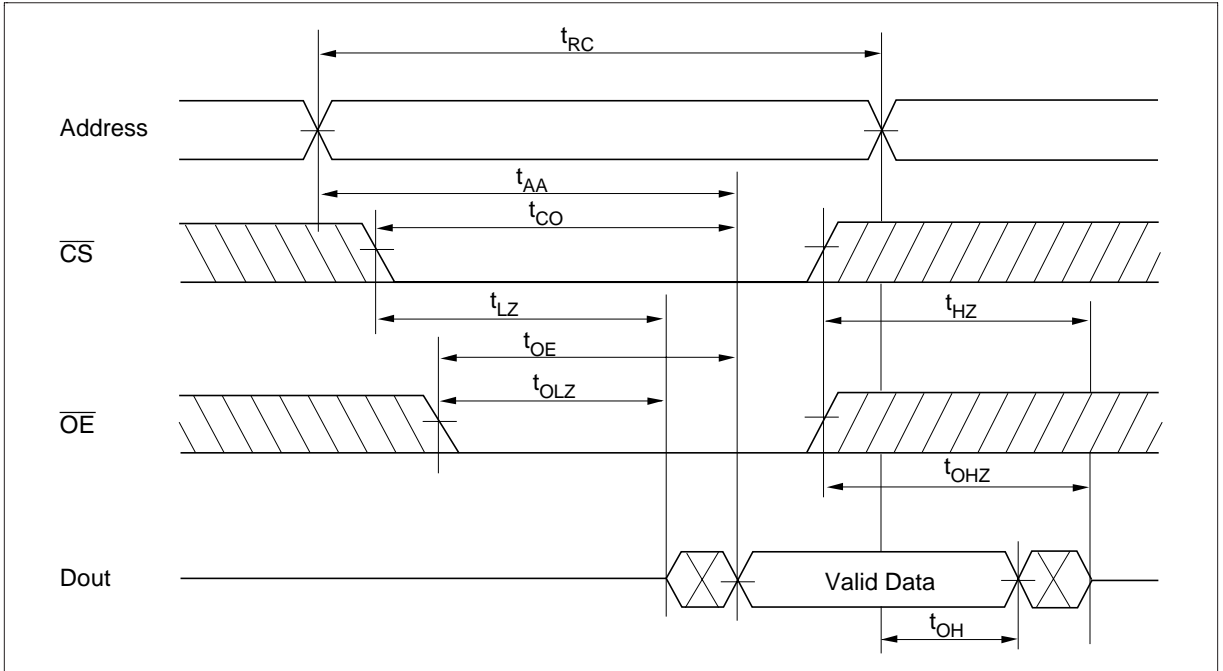
11. If  $\overline{CS}$  is low during this period, I/O pins are in the output state. Therefore, the input signals of the opposite phase to the outputs must not be applied to them.

12. In the write cycle with  $\overline{OE}$  low fixed,  $t_{WP}$  must satisfy the following equation to avoid a problem of data bus contention.  $t_{WP} \geq t_{DW} \min + t_{WHZ} \max$

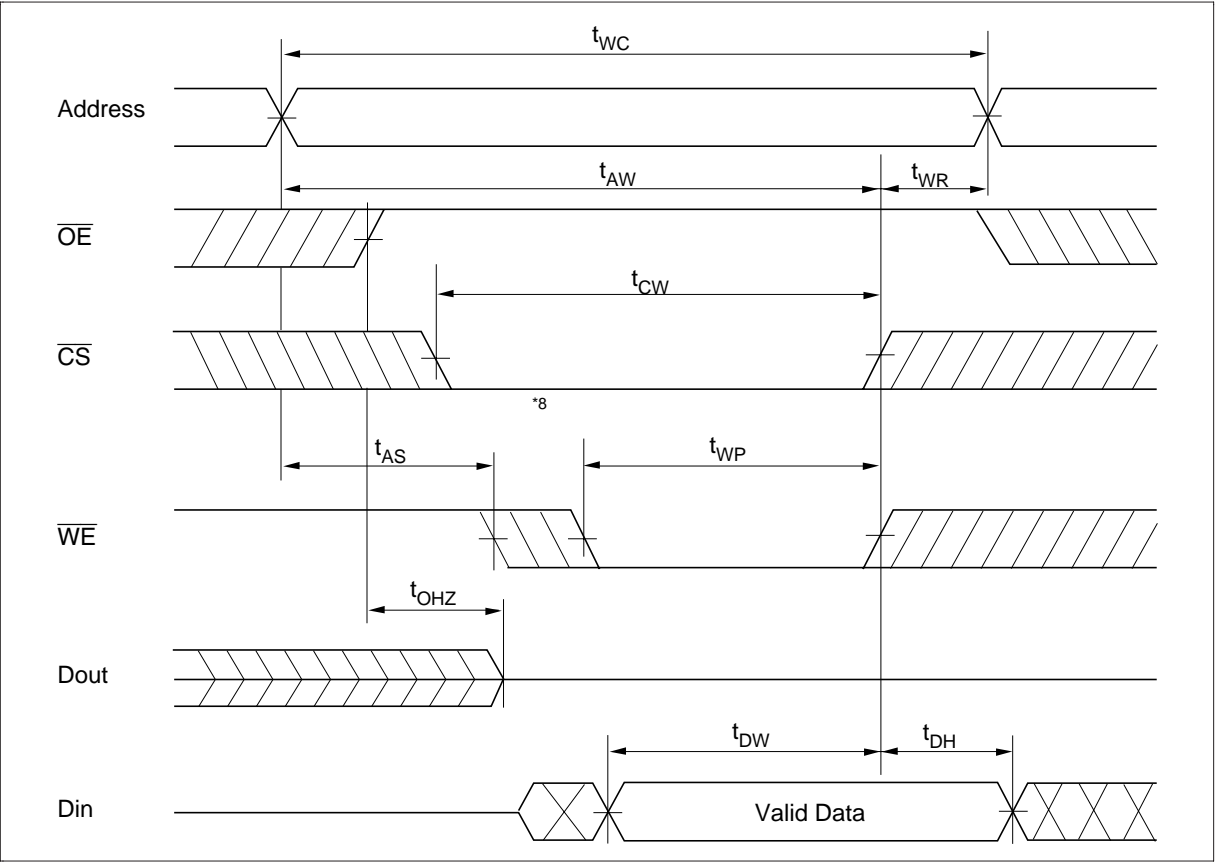


## Timing Waveforms

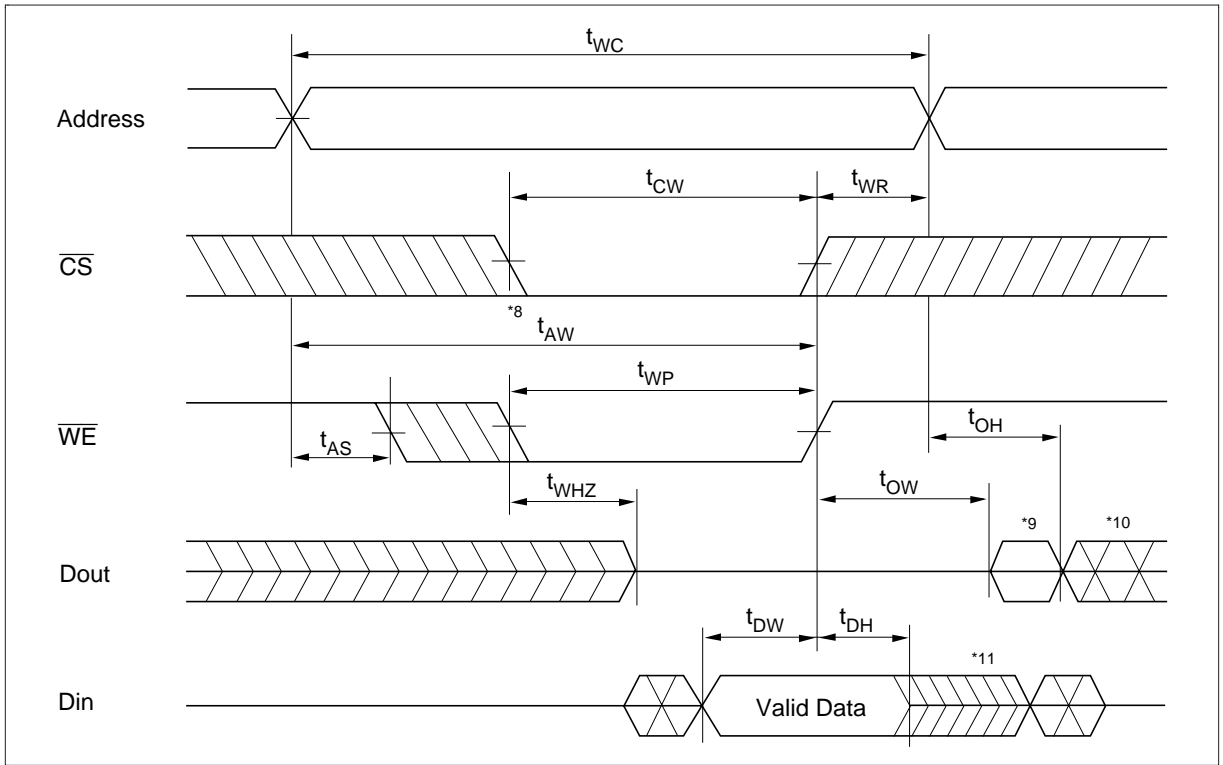
### Read Timing Waveform ( $\overline{WE} = V_{IH}$ )



Write Timing Waveform (1) ( $\overline{\text{OE}}$  Clock)



Write Timing Waveform (2) ( $\overline{\text{OE}}$  Low Fixed)

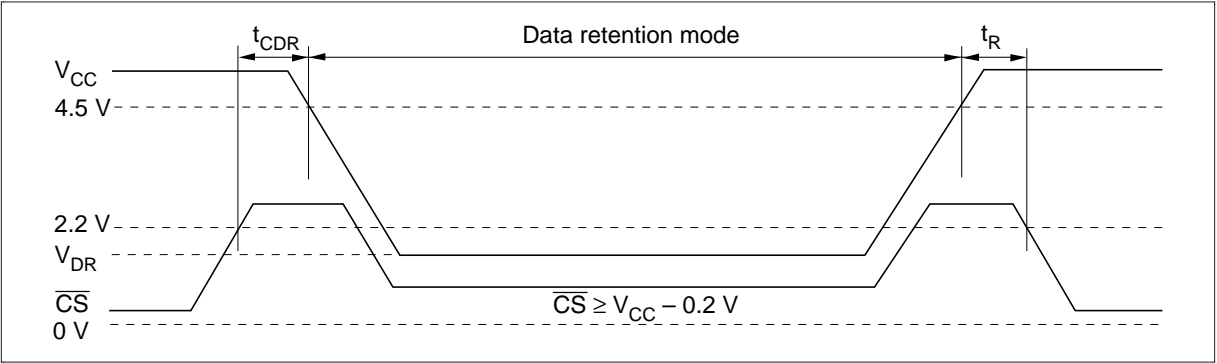


Low  $V_{CC}$  Data Retention Characteristics ( $T_a = -20$  to  $+70^{\circ}\text{C}$ )

Parameter	Symbol	Min	Typ	Max	Unit	Test conditions*3
$V_{CC}$ for data retention	$V_{DR}$	2	—	—	V	$\overline{CS} \geq V_{CC} - 0.2\text{ V}$ , $V_{in} \geq 0\text{ V}$
Data retention current	$I_{CCDR}$	—	0.8*4	20*1	$\mu\text{A}$	$V_{CC} = 3.0\text{ V}$ , $V_{in} \geq 0\text{ V}$ $\overline{CS} \geq V_{CC} - 0.2\text{ V}$
		—	0.8*4	10*2	$\mu\text{A}$	
Chip deselect to data retention time	$t_{CDR}$	0	—	—	ns	See retention waveform
Operation recovery time	$t_R$	$t_{RC}$ *5	—	—	ns	

- Notes: 1. For L-version and 10  $\mu\text{A}$  (max.) at  $T_a = -20$  to  $+40^{\circ}\text{C}$ .  
2. For L-SL-version and 3  $\mu\text{A}$  (max.) at  $T_a = -20$  to  $+40^{\circ}\text{C}$ .  
3.  $\overline{CS}$  controls address buffer,  $\overline{WE}$  buffer,  $\overline{OE}$  buffer, and  $D_{in}$  buffer. In data retention mode,  $V_{in}$  levels (address,  $\overline{WE}$ ,  $\overline{OE}$ , I/O) can be in the high impedance state.  
4. Typical values are at  $V_{CC} = 3.0\text{ V}$ ,  $T_a = +25^{\circ}\text{C}$  and specified loading, and not guaranteed.  
5.  $t_{RC}$  = read cycle time.

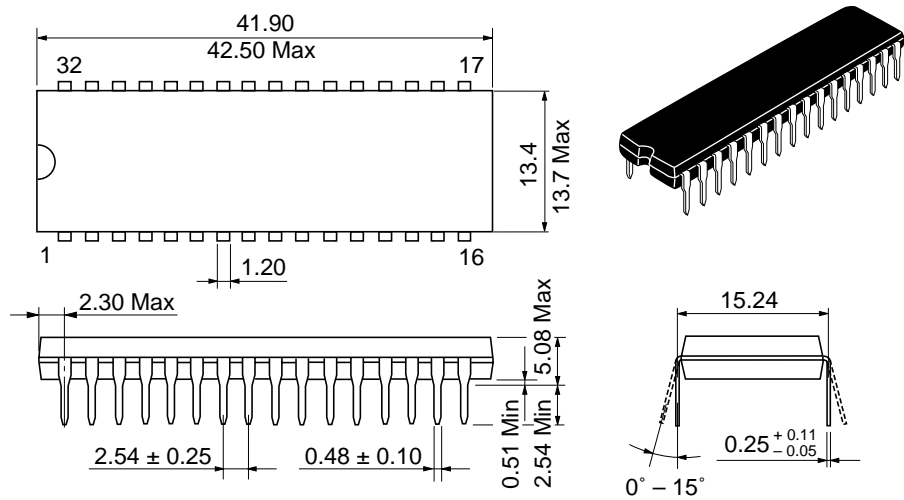
Low  $V_{CC}$  Data Retention Timing Waveform ( $\overline{CS}$  Controlled)



Package Dimensions

HM628512CLP Series (DP-32)

As of January, 2002  
Unit: mm



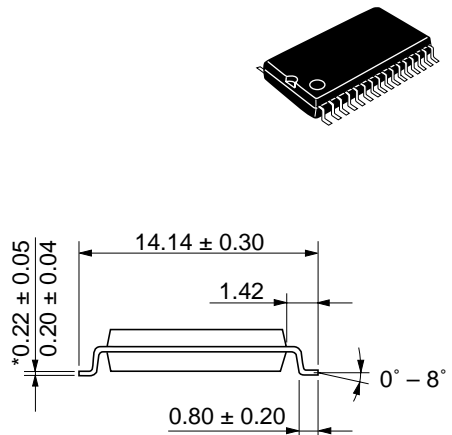
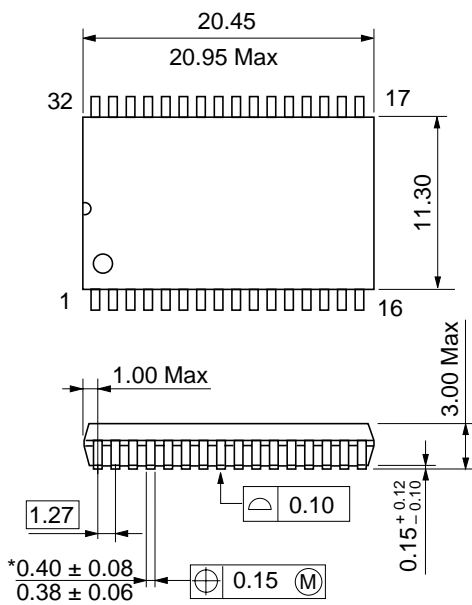
Hitachi Code	DP-32
JEDEC	—
JEITA	Conforms
Mass (reference value)	5.1 g

# HM628512C Series

## Package Dimensions (cont.)

### HM628512CLFP Series (FP-32D)

As of January, 2002  
Unit: mm



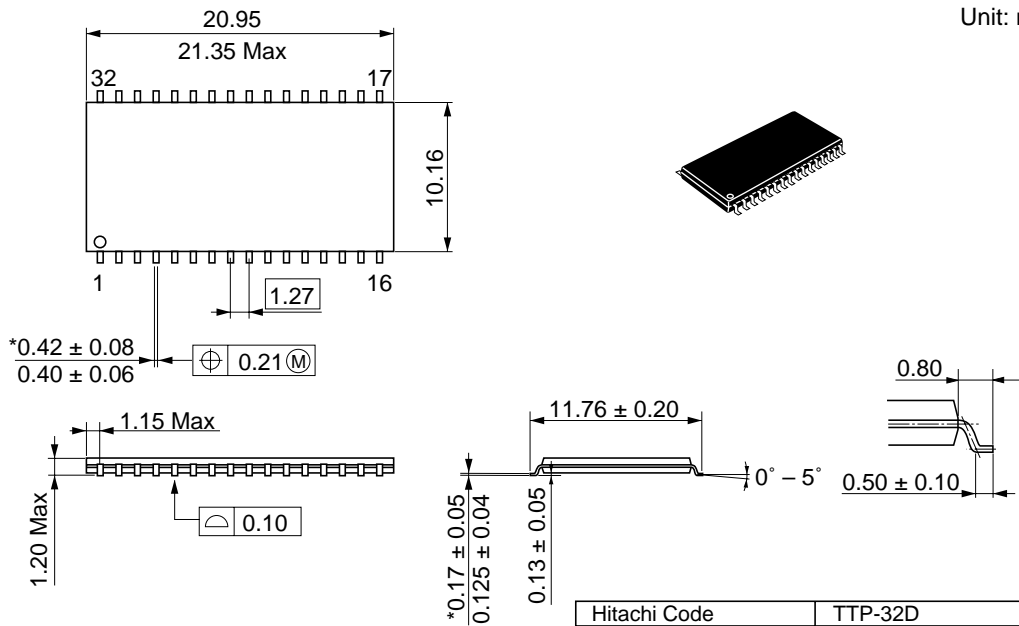
\*Dimension including the plating thickness  
Base material dimension

Hitachi Code	FP-32D
JEDEC	Conforms
JEITA	—
Mass (reference value)	1.3 g

Package Dimensions (cont.)

HM628512CLTT Series (TTP-32D)

As of January, 2002  
Unit: mm



\*Dimension including the plating thickness  
Base material dimension

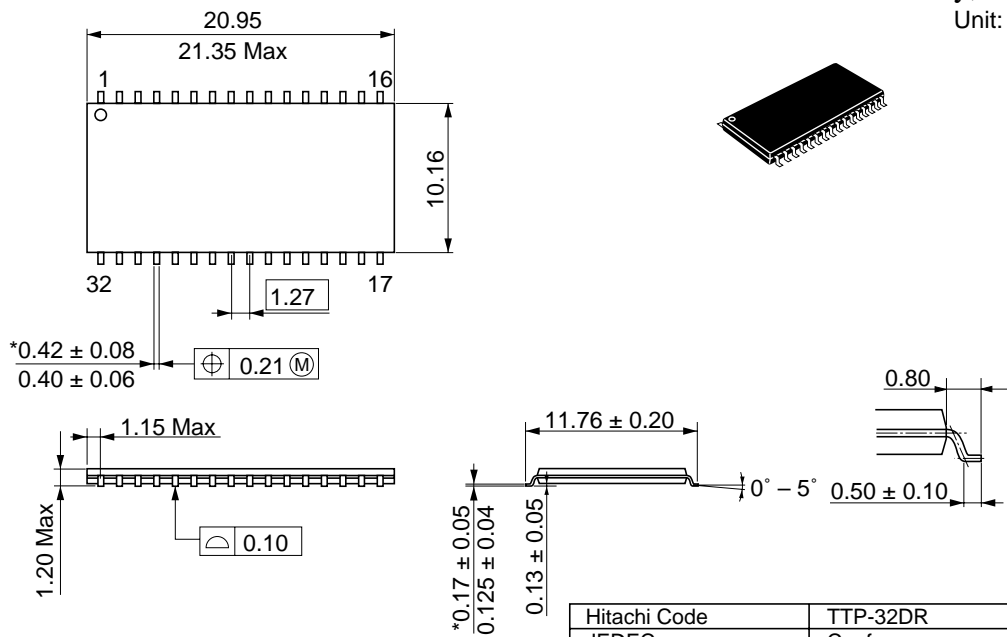
Hitachi Code	TTP-32D
JEDEC	Conforms
JEITA	—
Mass (reference value)	0.51 g

# HM628512C Series

## Package Dimensions (cont.)

### HM628512CLRR Series (TTP-32DR)

As of January, 2002  
Unit: mm



\*Dimension including the plating thickness  
Base material dimension

Hitachi Code	TTP-32DR
JEDEC	Conforms
JEITA	—
Mass (reference value)	0.51 g



## Cautions

1. Hitachi neither warrants nor grants licenses of any rights of Hitachi's or any third party's patent, copyright, trademark, or other intellectual property rights for information contained in this document. Hitachi bears no responsibility for problems that may arise with third party's rights, including intellectual property rights, in connection with use of the information contained in this document.
2. Products and product specifications may be subject to change without notice. Confirm that you have received the latest product standards or specifications before final design, purchase or use.
3. Hitachi makes every attempt to ensure that its products are of high quality and reliability. However, contact Hitachi's sales office before using the product in an application that demands especially high quality and reliability or where its failure or malfunction may directly threaten human life or cause risk of bodily injury, such as aerospace, aeronautics, nuclear power, combustion control, transportation, traffic, safety equipment or medical equipment for life support.
4. Design your application so that the product is used within the ranges guaranteed by Hitachi particularly for maximum rating, operating supply voltage range, heat radiation characteristics, installation conditions and other characteristics. Hitachi bears no responsibility for failure or damage when used beyond the guaranteed ranges. Even within the guaranteed ranges, consider normally foreseeable failure rates or failure modes in semiconductor devices and employ systemic measures such as fail-safes, so that the equipment incorporating Hitachi product does not cause bodily injury, fire or other consequential damage due to operation of the Hitachi product.
5. This product is not designed to be radiation resistant.
6. No one is permitted to reproduce or duplicate, in any form, the whole or part of this document without written approval from Hitachi.
7. Contact Hitachi's sales office for any questions regarding this document or Hitachi semiconductor products.

# HITACHI

## Hitachi, Ltd.

Semiconductor & Integrated Circuits  
Nippon Bldg., 2-6-2, Ohte-machi, Chiyoda-ku, Tokyo 100-0004, Japan  
Tel: (03) 3270-2111 Fax: (03) 3270-5109

URL <http://www.hitachisemiconductor.com/>

### For further information write to:

Hitachi Semiconductor (America) Inc.  
179 East Tasman Drive  
San Jose, CA 95134  
Tel: <1> (408) 433-1990  
Fax: <1> (408) 433-0223

Hitachi Europe Ltd.  
Electronic Components Group  
Whitebrook Park  
Lower Cookham Road  
Maidenhead  
Berkshire SL6 8YA, United Kingdom  
Tel: <44> (1628) 585000  
Fax: <44> (1628) 585200

Hitachi Europe GmbH  
Electronic Components Group  
Dornacher Strasse 3  
D-85622 Feldkirchen  
Postfach 201, D-85619 Feldkirchen  
Germany  
Tel: <49> (89) 9 9180-0  
Fax: <49> (89) 9 29 30 00

Hitachi Asia Ltd.  
Hitachi Tower  
16 Collyer Quay #20-00  
Singapore 049318  
Tel : <65>-6538-6533/6538-8577  
Fax : <65>-6538-6933/6538-3877  
URL : <http://semiconductor.hitachi.com.sg>

Hitachi Asia Ltd.  
(Taipei Branch Office)  
4/F, No. 167, Tun Hwa North Road  
Hung-Kuo Building  
Taipei (105), Taiwan  
Tel : <886>-(2)-2718-3666  
Fax : <886>-(2)-2718-8180  
Telex : 23222 HAS-TP  
URL : <http://www.hitachi.com.tw>

Hitachi Asia (Hong Kong) Ltd.  
Group III (Electronic Components)  
7/F., North Tower  
World Finance Centre,  
Harbour City, Canton Road  
Tsim Sha Tsui, Kowloon Hong Kong  
Tel : <852>-2735-9218  
Fax : <852>-2730-0281  
URL : <http://semiconductor.hitachi.com.hk>

Copyright©Hitachi, Ltd., 2002. All rights reserved. Printed in Japan.

Colophon 6.0